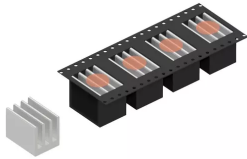


Data sheet Product ICK SMD K 19 MI B TR



Heatsinks and active heatsinks for processors>Heatsinks for DIL-IC, PLCC and SMD

10 x 6 mm, for SMD components and others

Features

case type:	SMD
thermal resistance:	18 K/W
surface:	solderable surface
diameter of tape:	330 mm
width of belt:	32 mm
quantity per reel:	215

Technical Drawing

